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TITLE: NI-780GH-2L	DOCUMENT NO: 98ASA00961D	REV: A
	STANDARD: NON-JEDEC	
	SOT1873-1	03 MAY 2016



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.

3. DIMENSION A1 MEASURED WITH REFERENCE TO DATUM T. THE POSITIVE VALUE IMPLIES THAT THE PACKAGE BOTTOM IS HIGHER THAN THE LEAD BOTTOM. TOLERANCE ON DIMENSION A1 IS TENTATIVE. WILL BE FINALIZED AT PACKAGE CERTIFICATION.

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
AA	1.335	1.345	33.91	34.16	N	.772	.788	19.60	20.02
BB	.380	.390	9.65	9.91	Q	∅.118	∅.138	∅3.00	∅3.51
CC	.125	.170	3.18	4.32	R	.365	.375	9.27	9.53
A1	.002	.008	0.05	0.20	S	.365	.375	9.27	9.53
B1	.546	.562	13.87	14.27	t'	0'	8'	0'	8'
D	.495	.505	12.57	12.83	aaa		.005		0.13
E	.035	.045	0.89	1.14	bbb		.010		0.25
F	.003	.006	0.08	0.15	ccc		.015		0.38
G	1.100 BSC		27.94 BSC						
L	.038	.046	0.97	1.17					
L1	.010 BSC		0.25 BSC						
M	.774	.786	19.66	19.96					

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